



1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 30A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 @3
- Polarity: Cathode Band or Cathode Notch
- Weight: SMA 0.064 grams (approximate) SMB 0.093 grams (approximate)







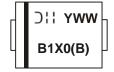
Ordering Information (Note 3)

Part Number	Case	Packaging
B1XX-13-F	SMA	5000/Tape & Reel
B1XXB-13-F	SMB	3000/Tape & Reel

^{*}xx = Device Type, e.g. B120-13-F (SMA Package); B120B-13-F (SMB Package).

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



B1X0 = Product type marking code, ex: B120 (SMA package) B1X0B = Product type marking code, ex: B160B (SMB package) >\| = Manufacturers' code marking YWW = Date code marking Y = Last digit of year (ex: 2 for 2002) WW = Week code (01 to 53)



Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	B120/B	B130/B	B140/B	B150/B	B160/B	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	20	30	40	50	60	V
RMS Reverse Voltage	V _{R(RMS)}	14	21	28	35	42	V
Average Rectified Output Current @ T _T = 130°C	lo			1.0			Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}			30			Α

Thermal Characteristics

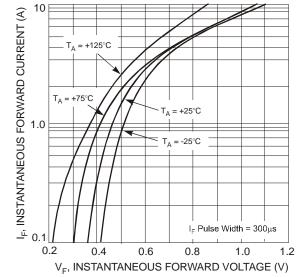
Characteristic	Symbol	B120/B	B130/B	B140/B	B150/B	B160/B	Unit
Typical Thermal Resistance Junction to Terminal (Note 4)	on to Terminal (Note 4) $R_{\theta JT}$ 20		°C/W				
Operating and Storage Temperature Range	T _{J.} T _{STG}			-65 to +150			°C

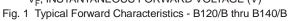
Electrical Characteristics @TA = 25°C unless otherwise specified

Chara	cteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	B120/B, B130/B, B140/B B150/B, B160/B	V_{F}	-	-	0.5 0.7	V	I _F = 1.0A I _F = 1.0A
Leakage Current (Note 5)		I _R	-	-	0.5 10	mA	@ Rated V _R , T _A = 25°C @ Rated V _R , T _A = 100°C
Total Capacitance		Ст	-	-	110	pF	$V_R = 4V, f = 1MHz$

Notes:

- 4. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm2 (0.013 mm thick) copper pads as heat sink.
- 5. Short duration pulse test used to minimize self-heating effect.





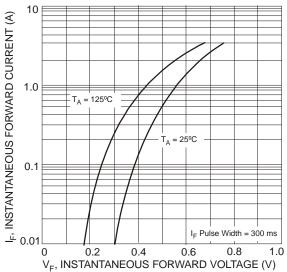
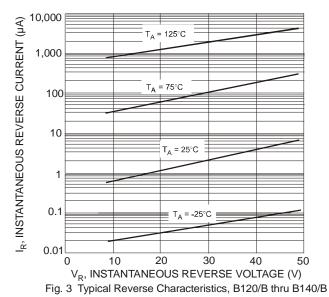
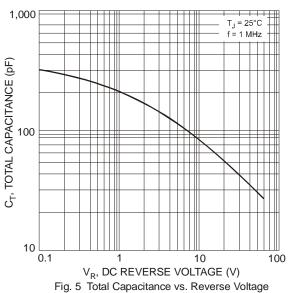


Fig. 2 Typical Forward Characteristics - B150/B thru B160/B







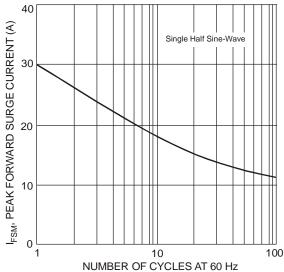
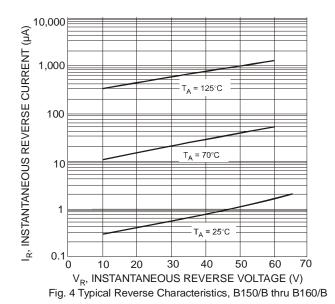
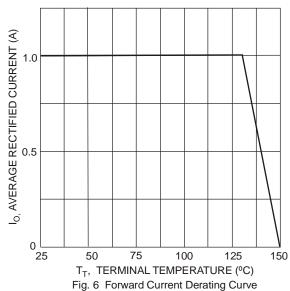


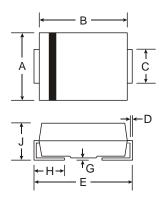
Fig. 7 Max Non-Repetitive Peak Forward Surge Current







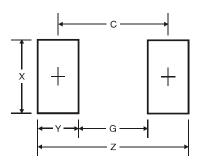
Package Outline Dimensions



SMA			
Dim	Min	Max	
Α	2.29	2.92	
В	4.00	4.60	
С	1.27	1.63	
D	0.15	0.31	
Е	4.80	5.59	
G	0.05	0.20	
Н	0.76	1.52	
J	2.01	2.30	
All Dimensions in mm			

SMB				
Dim	Min	Max		
Α	3.30	3.94		
В	4.06	4.57		
С	1.96	2.21		
D	0.15	0.31		
Е	5.00	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	2.00	2.50		
All Dimensions in mm				

Suggested Pad Layout



SMA Dimensions	Value (in mm)	
Z	6.5	
G	1.5	
Х	1.7	
Υ	2.5	
С	4.0	

SMB Dimensions	Value (in mm)
Z	6.7
G	1.8
X	2.3
Y	2.5
C	43



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